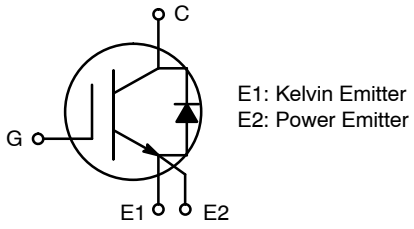
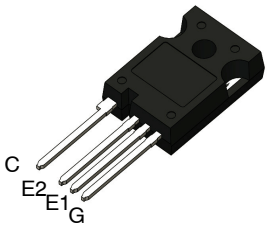
IGBT - Field Stop, Trench
650 V, 75 A

FGH75T65SQDTL4

V_{CES}	I_C
650 V	75 A





TO−247−4LD
CASE 340CJ

Description

Using novel field stop IGBT technology, **onsemi**'s new series of field stop 4th generation IGBTs offer the optimum performance for solar inverter, UPS, welder, telecom, ESS and PFC applications where low conduction and switching losses are essential.

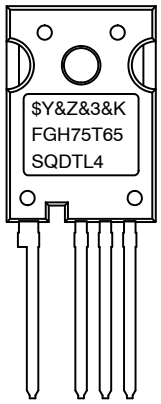
Features

- Maximum Junction Temperature: T_J = 175°C
- Positive Temperature Co−efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)}$ = 1.6 V @ I_C = 75 A
- 100% of the Parts Tested for I_{LM}
- High Input Impedance
- Fast Switching
- Tighten Parameter Distribution
- This Device is Pb−Free and is RoHS Compliant

Applications

- Solar Inverter, UPS, Welder, Telecom, ESS, PFC

MARKING DIAGRAM



$Y	= **onsemi** Logo
&Z	= Assembly Plant Code
&3	= Numeric Date Code
&K	= Lot Code
FGH75T65SQDTL4	= Specific Device Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

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ABSOLUTE MAXIMUM RATINGS

Symbol	Description		FGH75T65SQDTL4	Unit
V_{CES}	Collector to Emitter Voltage		650	V
V_{GES}	Gate to Emitter Voltage		±20	V
	Transient Gate to Emitter Voltage		±30	V
I_C	Collector Current	T_C = 25°C	150	A
		T_C = 100°C	75	A
I_{LM} (Note 1)	Pulsed Collector Current	T_C = 25°C	300	A
I_{CM} (Note 2)	Pulsed Collector Current		300	A
I_F	Diode Forward Current	T_C = 25°C	125	A
	Diode Forward Current	T_C = 100°C	75	A
I_{FM}	Pulsed Diode Maximum Forward Current		300	A
P_D	Maximum Power Dissipation	T_C = 25°C	375	W
		T_C = 100°C	188	W
T_J	Operating Junction Temperature		−55 to +175	°C
T_{STG}	Storage Temperature Range		−55 to +175	°C
T_L	Maximum Lead Temp. for Soldering Purposes, 1/8” from Case for 5 Seconds		300	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. V_{CC} = 400 V, V_{GE} = 15 V, I_C = 300 A, R_G = 26.4 Ω, Inductive Load.
2. Repetitive rating: Pulse width limited by max. junction temperature.

THERMAL CHARACTERISTICS

Symbol	Parameter	FGH75T65SQDT−F155	Unit
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case, Max.	0.4	°C/W
$R_{\theta JC}$ (Diode)	Thermal Resistance, Junction to Case, Max.	0.65	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient, Max.	40	°C/W

PACKAGE MARKING AND ORDERING INFORMATION

Part Number	Top Mark	Package	Reel Size	Tape Width	Qty per Tube
FGH75T65SQDTL4	FGH75T65SQDTL4	TO−247−4LD	−	−	30

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
BV_{CES}	Collector to Emitter Breakdown Voltage	V_{GE} = 0 V, I_C = 1 mA	650	–	–	V
$\Delta BV_{CES} / \Delta T_J$	Temperature Coefficient of Breakdown Voltage	V_{GE} = 0 V, I_C = 1 mA	–	0.6	–	V/°C
I_{CES}	Collector Cut−Off Current	V_{CE} = V_{CES}, V_{GE} = 0 V	–	–	250	μA
I_{GES}	G−E Leakage Current	V_{GE} = V_{GES}, V_{CE} = 0 V	–	–	±400	nA
ON CHARACTERISTICS						
$V_{GE(th)}$	G−E Threshold Voltage	I_C = 75 mA, V_{CE} = V_{GE}	2.6	4.5	6.4	V
$V_{CE(sat)}$	Collector to Emitter Saturation Voltage	I_C = 75 A, V_{GE} = 15 V	–	1.6	2.1	V
		I_C = 75 A, V_{GE} = 15 V, T_C = 175°C	–	1.92	–	V
DYNAMIC CHARACTERISTICS						
C_{ies}	Input Capacitance	V_{CE} = 30 V, V_{GE} = 0 V, f = 1MHz	–	4845	–	pF
C_{oes}	Output Capacitance		–	155	–	pF
C_{res}	Reverse Transfer Capacitance		–	14	–	pF
SWITCHING CHARACTERISTICS						
$T_{d(on)}$	Turn−On Delay Time	V_{CC} = 400 V, I_C = 18.8 A, R_G = 15 Ω, V_{GE} = 15 V, Inductive Load, T_C = 25°C	–	44	–	ns
T_r	Rise Time		–	20	–	ns
$T_{d(off)}$	Turn−Off Delay Time		–	276	–	ns
T_f	Fall Time		–	32	–	ns
E_{on}	Turn−On Switching Loss		–	307	–	μJ
E_{off}	Turn−Off Switching Loss		–	266	–	μJ
E_{ts}	Total Switching Loss		–	573	–	μJ
$T_{d(on)}$	Turn−On Delay Time	V_{CC} = 400 V, I_C = 37.5 A, R_G = 15 Ω, V_{GE} = 15 V, Inductive Load, T_C = 25°C	–	44	–	ns
T_r	Rise Time		–	32	–	ns
$T_{d(off)}$	Turn−Off Delay Time		–	264	–	ns
T_f	Fall Time		–	28	–	ns
E_{on}	Turn−On Switching Loss		–	599	–	μJ
E_{off}	Turn−Off Switching Loss		–	608	–	μJ
E_{ts}	Total Switching Loss		–	1207	–	μJ
$T_{d(on)}$	Turn−On Delay Time	V_{CC} = 400 V, I_C = 18.8 A, R_G = 15 Ω, V_{GE} = 15 V, Inductive Load, T_C = 150°C	–	40	–	ns
T_r	Rise Time		–	24	–	ns
$T_{d(off)}$	Turn−Off Delay Time		–	316	–	ns
T_f	Fall Time		–	36	–	ns
E_{on}	Turn−On Switching Loss		–	730	–	μJ
E_{off}	Turn−Off Switching Loss		–	408	–	μJ
E_{ts}	Total Switching Loss		–	1138	–	μJ

ELECTRICAL CHARACTERISTICS OF THE IGBT (T_C = 25°C unless otherwise noted) (continued)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
SWITCHING CHARACTERISTICS						
$T_{d(on)}$	Turn−On Delay Time	V_{CC} = 400 V, I_C = 37.5 A, R_G = 15 Ω, V_{GE} = 15 V, Inductive Load, T_C = 150°C	–	44	–	ns
T_r	Rise Time		–	36	–	ns
$T_{d(off)}$	Turn−Off Delay Time		–	296	–	ns
T_f	Fall Time		–	32	–	ns
E_{on}	Turn−On Switching Loss		–	1240	–	μJ
E_{off}	Turn−Off Switching Loss		–	853	–	μJ
E_{ts}	Total Switching Loss		–	2093	–	μJ
Q_g	Total Gate Charge	V_{CE} = 400 V, I_C = 75 A, V_{GE} = 15 V	–	128	–	nC
Q_{ge}	Gate to Emitter Charge		–	23	–	nC
Q_{gc}	Gate to Collector Charge		–	29	–	nC

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

ELECTRICAL CHARACTERISTICS OF THE DIODE (T_C = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions		Min	Typ	Max	Unit
V_{FM}	Diode Forward Voltage	I_F = 75 A	T_C = 25°C	–	1.8	2.1	V
			T_C = 175°C	–	1.7	–	
E_{rec}	Reverse Recovery Energy	I_F = 75 A, dI_F/dt = 200 A/μs	T_C = 175°C	–	160	–	μJ
T_{rr}	Diode Reverse Recovery Time		T_C = 25°C	–	76	–	ns
			T_C = 175°C	–	270	–	
Q_{rr}	Diode Reverse Recovery Charge		T_C = 25°C	–	206	–	nC
			T_C = 175°C	–	2199	–	

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

TYPICAL PERFORMANCE CHARACTERISTICS

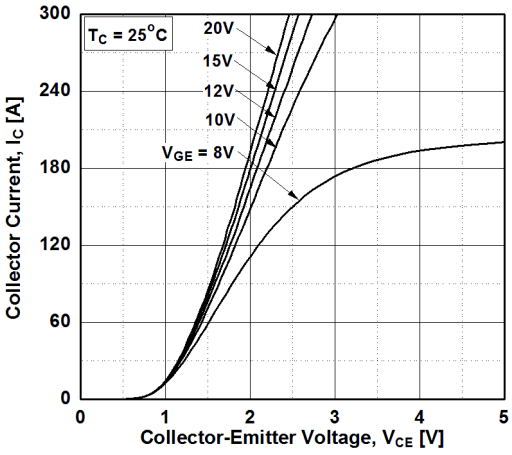


Figure 1. Typical Output Characteristics

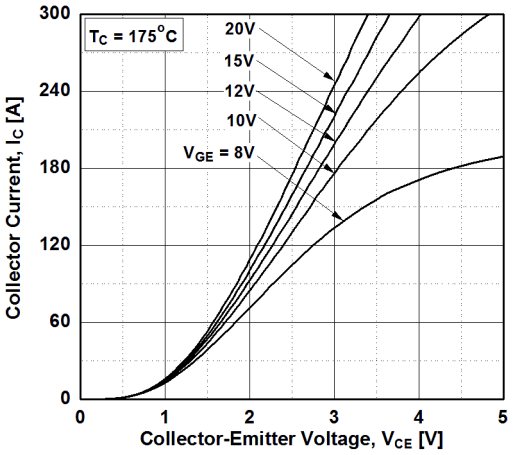


Figure 2. Typical Output Characteristics

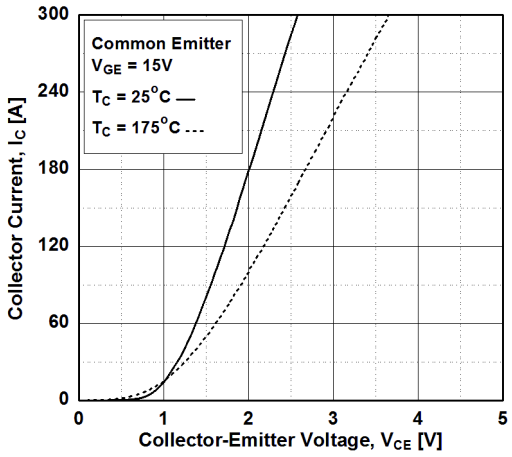


Figure 3. Typical Saturation Voltage Characteristics

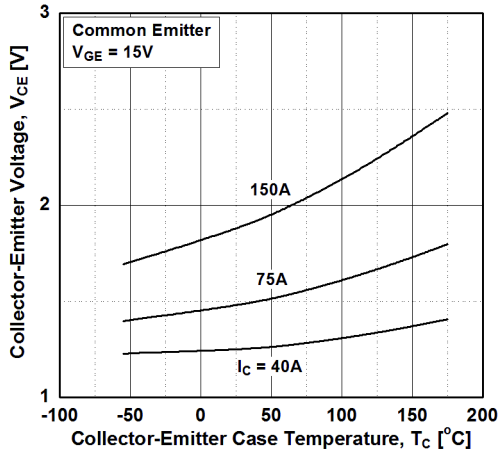


Figure 4. Saturation Voltage vs. Case Temperature at Variant Current Level

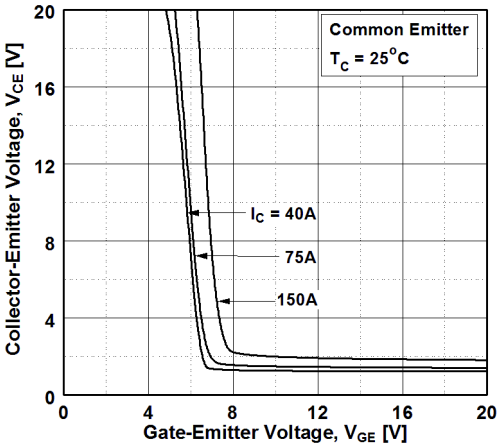


Figure 5. Saturation Voltage vs. V_{GE}

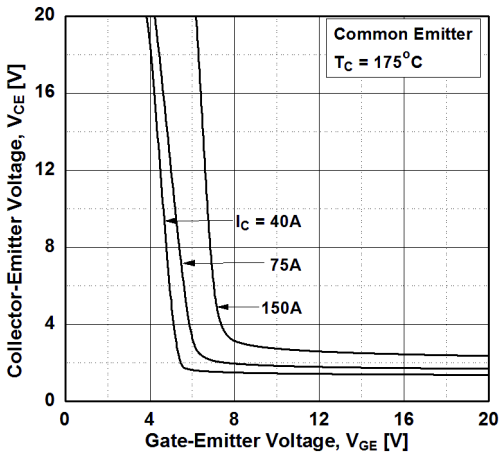


Figure 6. Saturation Voltage vs. V_{GE}

TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)

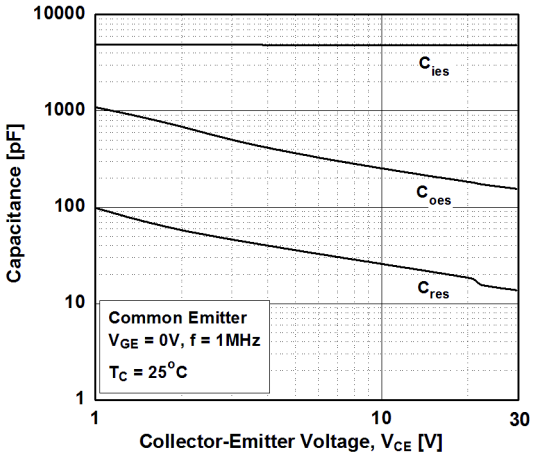


Figure 7. Capacitance Characteristics

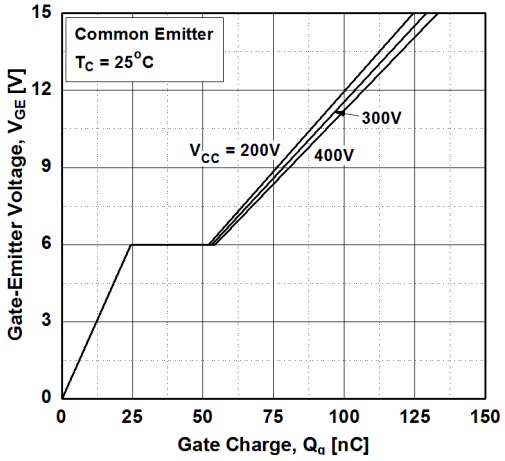


Figure 8. Gate Charge Characteristics

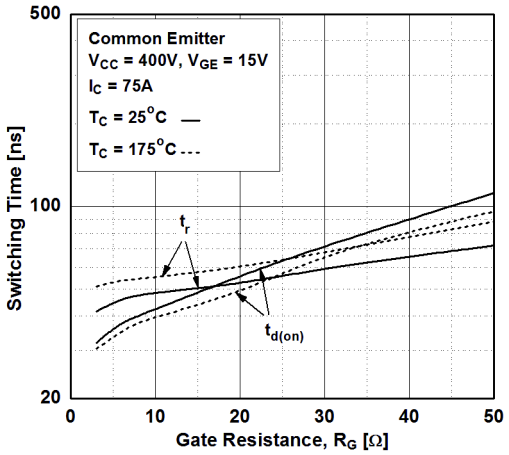


Figure 9. Turn−on Characteristics vs. Gate Resistance

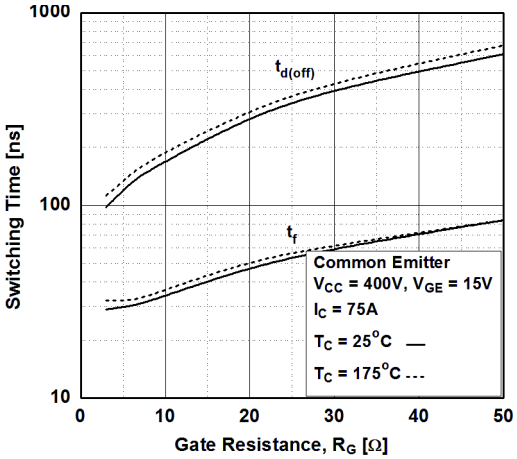


Figure 10. Turn−off Characteristics vs. Gate Resistance

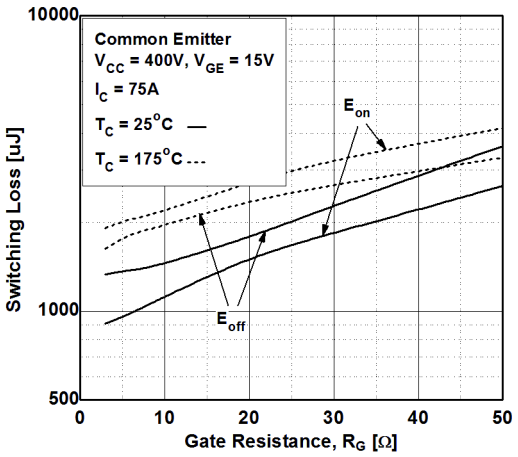


Figure 11. Switching Loss vs. Gate Resistance

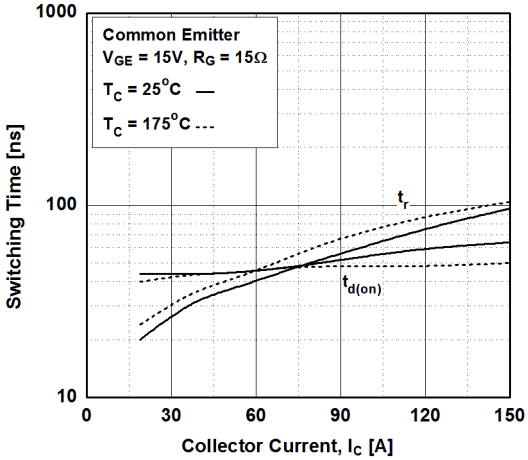


Figure 12. Turn−on Characteristics vs. Collector Current

TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)

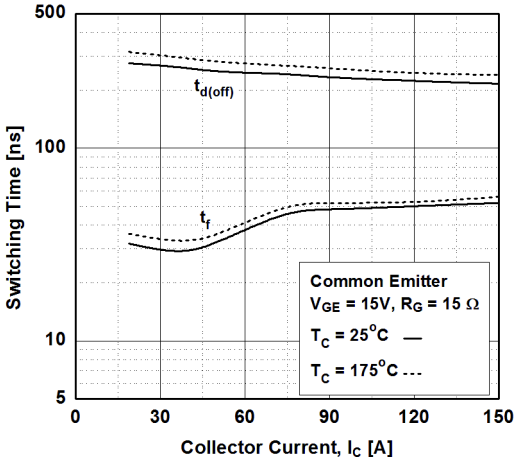


Figure 13. Turn−off Characteristics vs. Collector Current

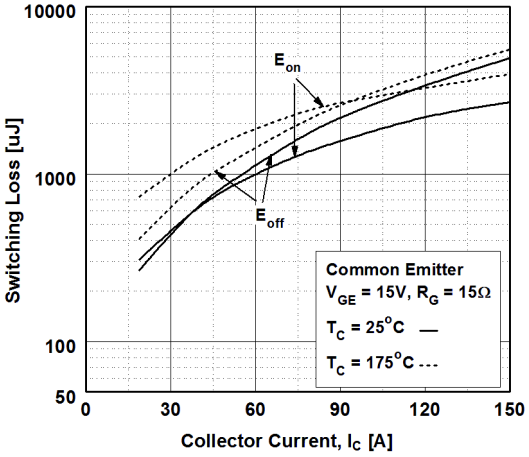


Figure 14. Switching Loss vs. Collector Current

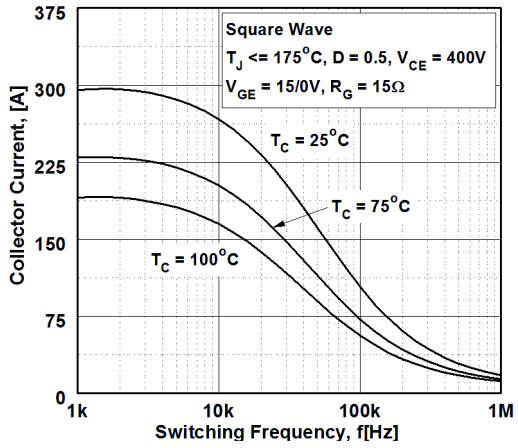


Figure 15. Load Current vs. Frequency

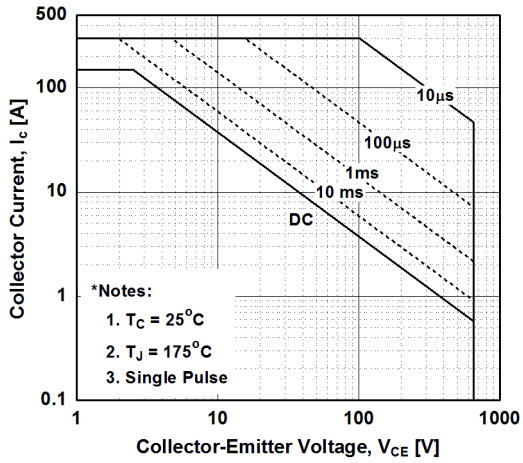


Figure 16. SOA Characteristics

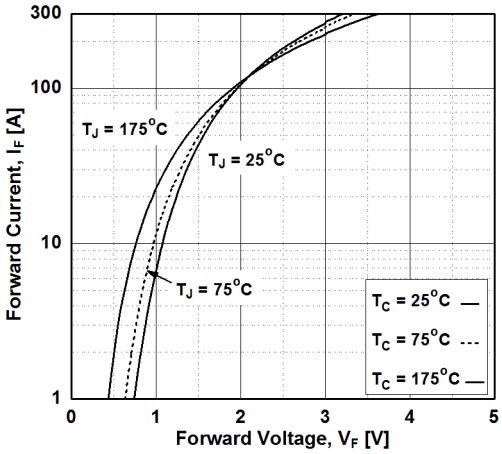


Figure 17. Forward Characteristics

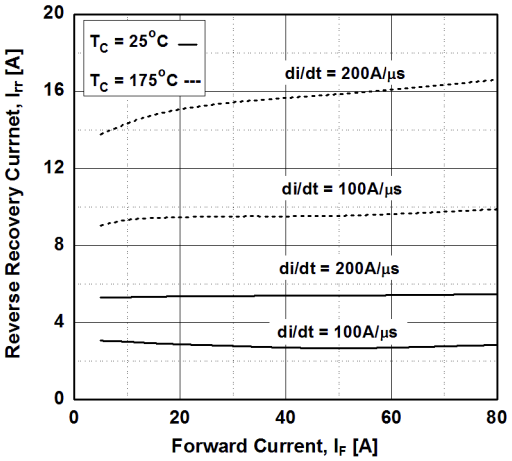


Figure 18. Reverse Recovery Current

TYPICAL PERFORMANCE CHARACTERISTICS (CONTINUED)

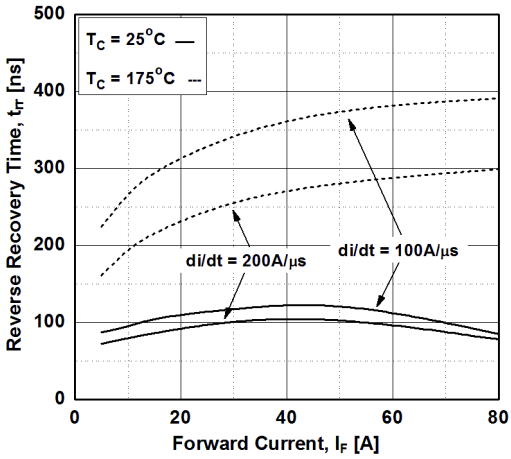


Figure 19. Reverse Recovery Time

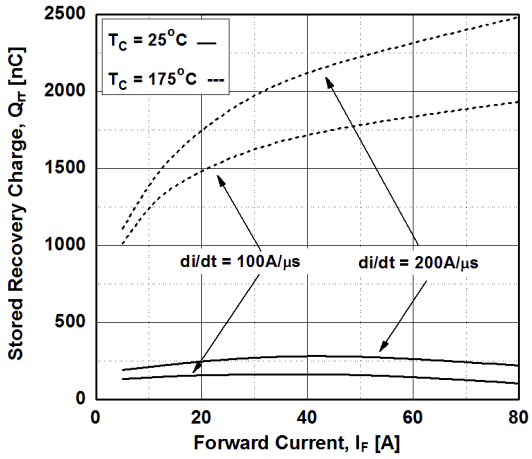


Figure 20. Stored Charge

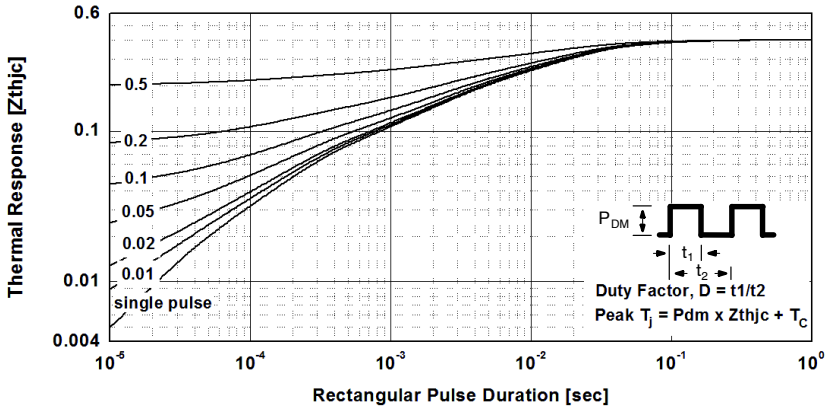


Figure 21. Transient Thermal Impedance of IGBT

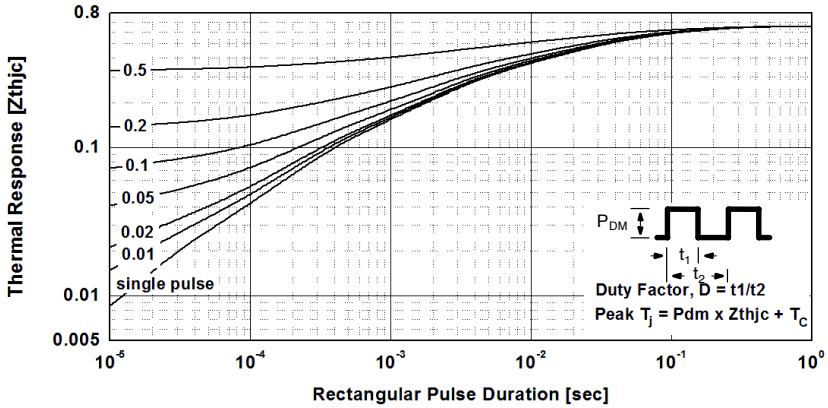
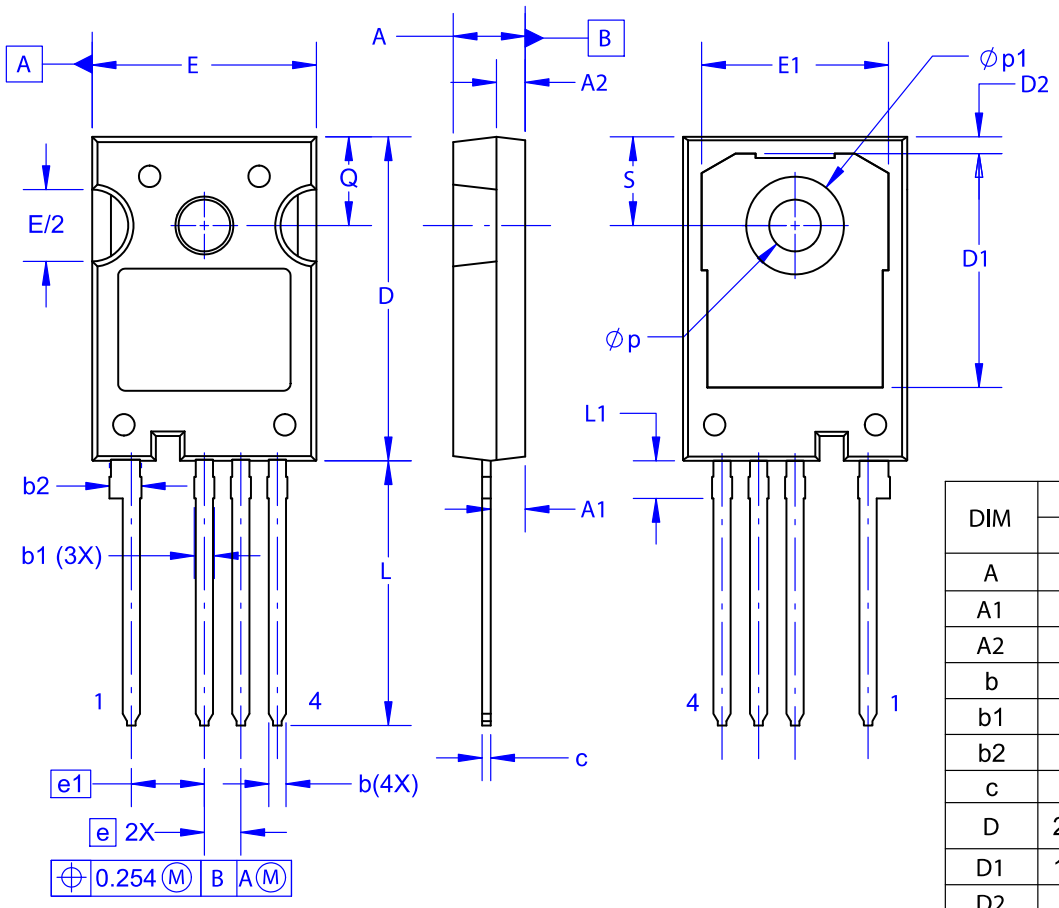


Figure 22. Transient Thermal Impedance of Diode

TO−247−4LD
CASE 340CJ
ISSUE A

DATE 16 SEP 2019



NOTES:

A. NO INDUSTRY STANDARD APPLIES TO THIS PACKAGE.
B. DIMENSIONS ARE EXCLUSIVE OF BURRS,MOLD FLASH,AND TIE BAR EXTRUSIONS.
C. ALL DIMENSIONS ARE IN MILLIMETERS.
D. DRAWING CONFORMS TO ASME Y14.5-2009.

DIM	MILLIMETERS		
	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.10	2.40	2.70
A2	1.80	2.00	2.20
b	1.07	1.20	1.33
b1	1.20	1.40	1.60
b2	2.02	2.22	2.42
c	0.50	0.60	0.70
D	22.34	22.54	22.74
D1	16.00	16.25	16.50
D2	0.97	1.17	1.37
e	2.54 BSC		
e1	5.08 BSC		
E	15.40	15.60	15.80
E1	12.80	13.00	13.20
E/2	4.80	5.00	5.20
L	18.22	18.42	18.62
L1	2.42	2.62	2.82
p	3.40	3.60	3.80
p1	6.60	6.80	7.00
Q	5.97	6.17	6.37
S	5.97	6.17	6.37

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DESCRIPTION:	**TO−247−4LD**	**PAGE 1 OF 1**

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For additional information, please contact your local Sales Representative at www.onsemi.com/support/sales

ENTEGRECİ

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Elektronik komponent tedarikinde Entegreci

Entegreci, Eskişehir merkezli, Türkiye geneline satış yapan bir elektronik komponent mağazasıdır. Entegreler (IC), mikrodenetleyiciler, transistörler, diyotlar, pasif elemanlar, konnektörler, modüller ve geliştirme kartları tek adetten seri üretim adetlerine kadar satılır. Ürün sayfalarında güncel stok durumunu, fiyatı ve datasheet bağlantısını bulabilirsiniz.

Parça koduyla arama

Üretici parça numarasını yazın; stok ve fiyatı hemen görün.

www.entegreci.com

Ürün kategorileri

Entegreden kapasitöre tüm elektronik komponent kategorileri.

Kategorilere göz atın

Üreticiler

Aradığınız üreticinin ürünlerini tek sayfada inceleyin.

Üreticileri görün

Toplu alım ve teklif

Listede olmayan ya da yüksek adetli parçalar için teklif isteyin.

Teklif isteyin

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